

## EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L3	4432583	(trench recessg groove hole open\$3 mesa)	US-PGPU B; USPAT; USOCR	OR	ON	2006/07/31 14:09
L4	71317	L3 and (polysilicon (poly near5 crystal\$3 near5 silicon))	US-PGPU B; USPAT; USOCR	OR	ON	2006/07/31 14:09
L5	1899	L4 and ((remov\$3 etch\$3) near5 (polysilicon (poly near5 crystal\$3 near5 silicon)) near8 (polish\$3 CMP))	US-PGPU B; USPAT; USOCR	OR	ON	2006/07/31 14:17
L6	3731142	(trench recessg groove hole open\$3 mesa)	EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/07/31 14:09
L7	11357	L6 and (polysilicon (poly near5 crystal\$3 near5 silicon))	EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/07/31 14:09
L8	585	L7 and ((remov\$3 etch\$3) same (polysilicon (poly same crystal\$3 same silicon)) same (polish\$3 CMP))	EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/07/31 14:10
L9	17	((remov\$3 etch\$3) near5 (polysilicon (poly near5 crystal\$3 near5 silicon)) near8 (polish\$3 CMP)) near8 temperature	US-PGPU B; USPAT; USOCR	OR	ON	2006/07/31 14:20
L10	35	(polysilicon (poly near5 crystal\$3 near5 silicon)) near8 (polish\$3 CMP) near8 temperature	US-PGPU B; USPAT; USOCR	OR	ON	2006/07/31 14:22
L11	19	(polysilicon (poly near5 crystal\$3 near5 silicon)) near8 (polish\$3 CMP) near8 temperature	EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/07/31 14:22